

## Audio Accessory ICs

# Preamps with Built-in ALC



**BA3308F,BA3308FV**

No.11087ECT01

### ●Description

The BA3308F/FV is a dual preamplifier for recording and playback with ALC (auto level control), developed for stereo radio, cassette recorders, tape recorders, and other pre amplifiers audio applications.

ALC circuit has a build in rectification circuit with wide adjustable dynamic range, high gain, low distortion amplifiers with direct coupling and mute circuit, used to cut off pop noise during power on.

Available in SOP14, or SSOP-B14 Packages.

### ●Features

- 1) Built-in ALC rectification diode
- 2) Wide operating power supply voltage range ( $V_{CC}=4.5\sim14\text{ V}$ )
- 3) Low current consumption ( $I_q=3.5\text{mA}$ )
- 4) High gain ( $G_{vo}=80\text{dB}$ )
- 5) Low distortion ( $\text{THD}=0.1\%$ )
- 6) Low noise ( $V_{NIN}=1\text{ }\mu\text{V}_{\text{rms}}$ )
- 7) Input coupling capacitor not needed
- 8) Good ALC channel balance
- 9) Built-in power supply mute circuit
- 10) Dynamic range of ALC can be changed by attaching input resistance.

### ●Applications

Stereo radio, cassette tape recorders, stereo cassette decks, home stereos, music centers, etc.

### ●Line up matrix

Part No.	BA3308F	BA3308FV
Package	SOP14	SSOP-B14

● **Absolute maximum ratings**(Ta=25°C)

Parameter		Symbol	Limits	Unit
Supply voltage		V <sub>CC</sub>	16	V
Power dissipation	BA3308F	Pd	450 <sup>*1</sup>	mW
	BA3308FV		350 <sup>*2</sup>	
Operating temperature		Topr	-25~+75	°C
Storage temperature		Tstg	-55~+125	°C

<sup>\*1</sup> Reduce by 4.5 mW/°C over 25°C, when mounted on a 70mm × 70mm × 1.6mm PCB board.

<sup>\*2</sup> Reduce by 3.5 mW/°C over 25°C

● **Operating conditions**(Ta=25°C)

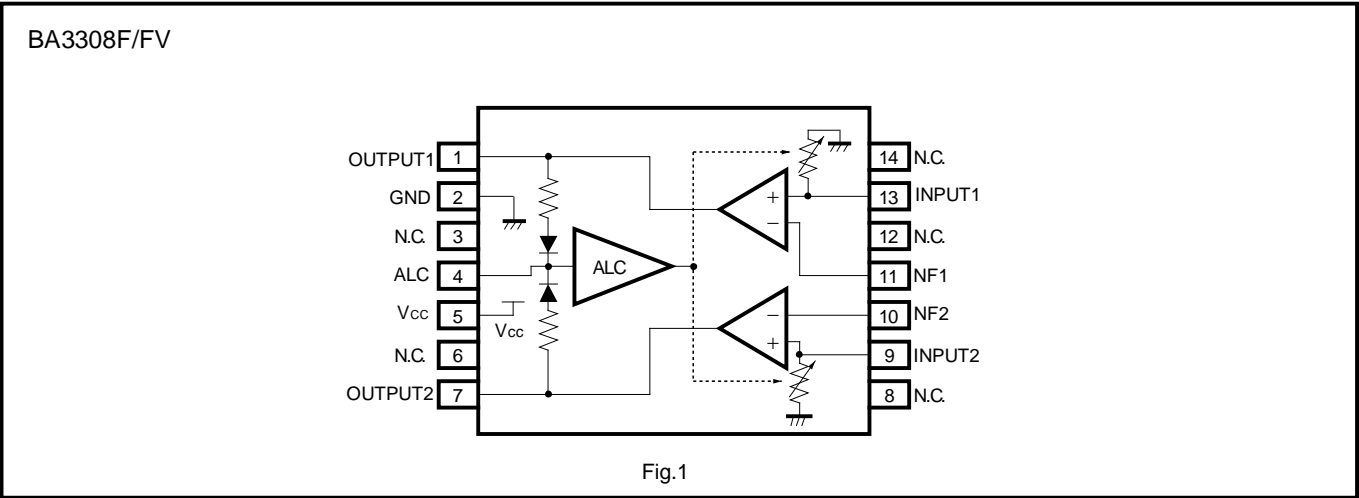
Parameter	Symbol	Min.	Typ.	Max.	Unit
Supply voltage	V <sub>CC</sub>	4.5	-	14	V

Note: This IC is not designed to be radiation-resistant.

● **Electrical characteristics**(Unless otherwise noted, Ta=25°C, V<sub>CC</sub>=7.0V, f=1kHz, BPF20~20kHz)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions	Test Circuit
Quiescent current	I <sub>Q</sub>	1.5	3.5	4.5	mA	V <sub>IN</sub> =0V <sub>rms</sub>	Fig.17
Open loop voltage gain	G <sub>VO</sub>	70	80	-	dB	V <sub>OUT</sub> =-10dBV	Fig.17
Total harmonic distortion	THD	-	0.1	0.3	%	NAB34dB, V <sub>OUT</sub> =40mV <sub>rms</sub>	Fig.17
Input resistance	R <sub>IN</sub>	15	25	45	kΩ		Fig.17
Maximum output voltage	V <sub>OM</sub>	0.6	1.2	-	V <sub>rms</sub>	THD=1%	Fig.17
Input conversion noise voltage	V <sub>NIN</sub>	-	1	2	μV <sub>rms</sub>	R <sub>g</sub> =2.2kΩ, referenced to NAB 34dB at 1kHz	Fig.17
ALC range	ALC	40	45	-	dB	R <sub>g</sub> =3.9 kΩ, V <sub>IN</sub> =-70 dBV standard, THD=3%	Fig.17
ALC channel balance	ΔALC	-	0	2.5	dB	V <sub>IN</sub> =-60dBV,-30dBV	Fig.17
Channel separation	CS	60	75	-	dB	V <sub>O</sub> =0dBV, NAB 34dB	Fig.17

●Block diagram



# ●Electrical characteristic curves (Reference data)

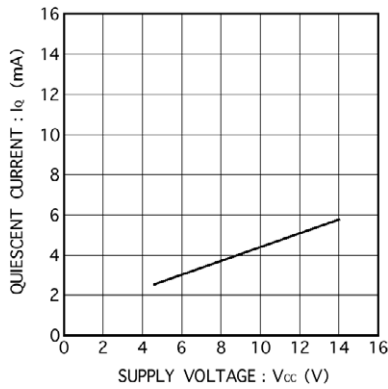


Fig.2 Quiescent current vs. power supply voltage

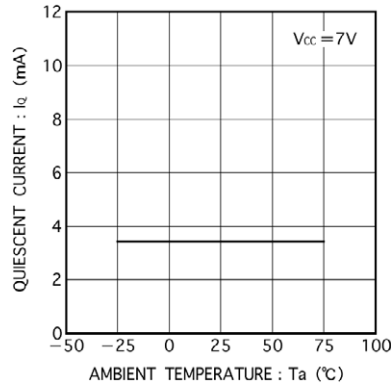


Fig.3 Quiescent current vs. ambient temperature

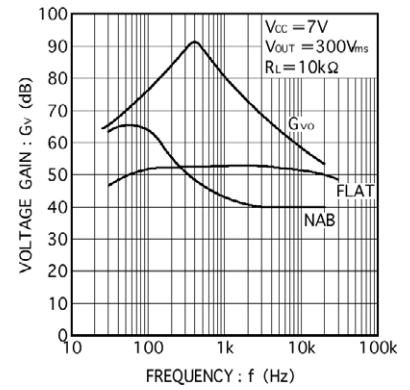


Fig.4 Voltage gain vs. frequency

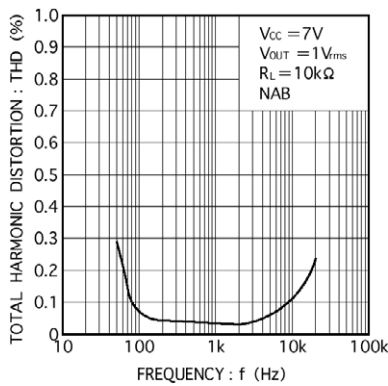


Fig.5 Total harmonic distortion vs. frequency

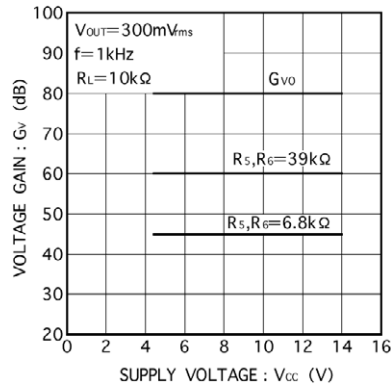


Fig.6 Voltage gain vs. supply voltage

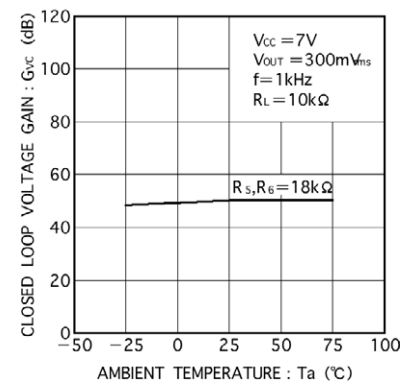


Fig.7 Closed loop voltage gain vs. ambient temperature

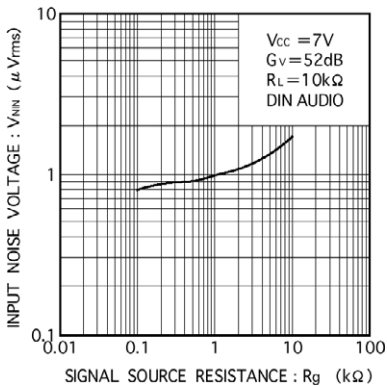


Fig.8 Input conversion noise voltage vs. signal source resistance

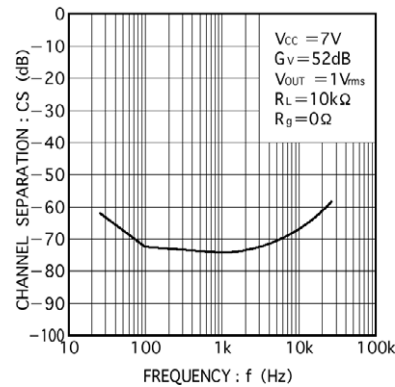


Fig.9 Channel separation vs. frequency

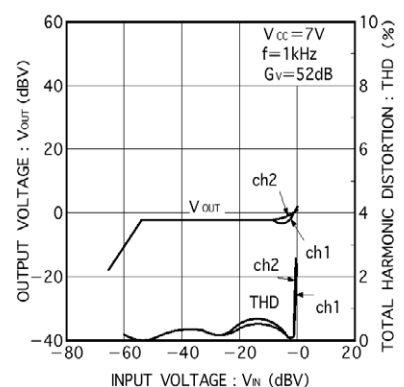


Fig.10 ALC characteristics

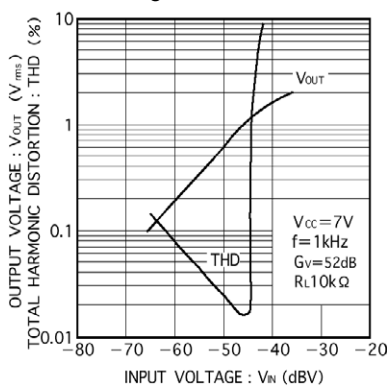


Fig.11 Input/output characteristics

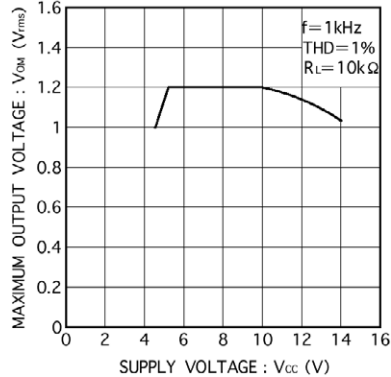


Fig.12 Maximum output voltage vs. power supply voltage

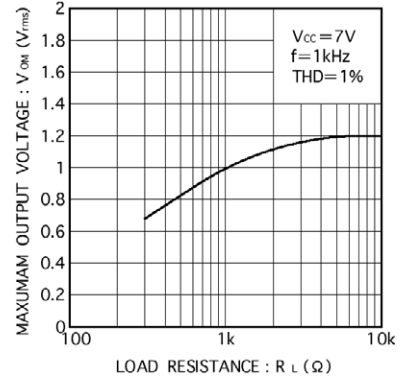


Fig.13 Maximum output voltage vs. load resistance

### ●Description of operations

## 1. Recording

1) Record amplifier

The BA3308F/V amplifier of ch1 and ch2 input stage (13pin, 9pin) can be direct coupled or use coupling capacitors (C1/C2). The voltage gain of the record amplifier is determined by  $G_v = R_5/R_3$ . The  $R_5/R_6$ , and  $C_3/R_3$  regulate control of the pop noise that occurs at power-on (see "Cautions on use") and direct current bias fed back is set by  $R_5/R_6$  and  $C_5/C_6$  at the output stage.

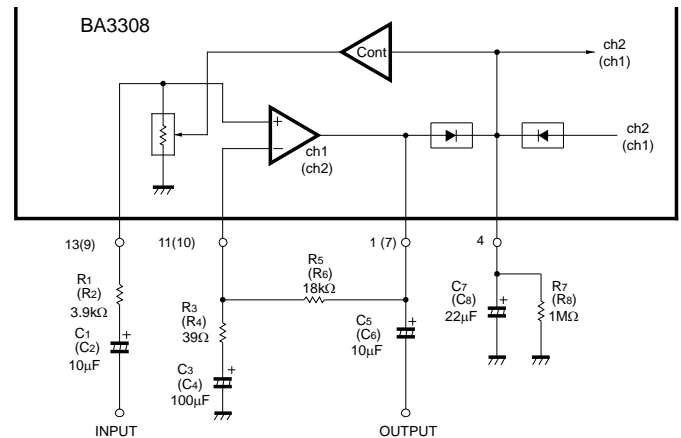


Fig.14

2) ALC

The BA3308F/V has an on-chip signal rectifier and electronic volume needed for ALC. The signal rectifier compares the direct current output voltage that is superposed in the output stage (1, 7pin) signal to the reference voltage  $4.5V_F$  ( $\approx 3V$ ;  $1V_F$  is approximately  $0.7V$ ) in the comparator circuit and if the output voltage is higher, it turns the comparator ON to charge the smoothing capacitor  $C_7$ . Since the operation point of the output stage of amplifier ch1 and ch2 is fixed at  $3V_F$ , the comparator turns ON when the peak value of the signal output voltage is  $1.5V_F$  (effective value approx.  $0.75V$ ). Once the direct current signal for electronic volume is controlled, ALC operation starts. The electronic volume, which is connected between the input line (13, 9pin) and GND, causes the input signal to attenuate according to the ratio of the external resistance ( $R_1$ ,  $R_2$ ) to the resistance value of the electronic volume. The ALC range varies according to the values of  $R_1$  and  $R_2$ . For small ALC variation the S/N will determinate an adequate ALC range is obtained by applying several k $\Omega$  of the  $R_1$  and  $R_2$ . The attack time and recovery time of ALC are set according to  $C_7$  and  $R_7$  of 4pin. If the time constants ( $C_7$ ,  $R_7$ ) are large, the recovery time will be long and as  $C_7$  becomes smaller, and the attack time will be shorter.

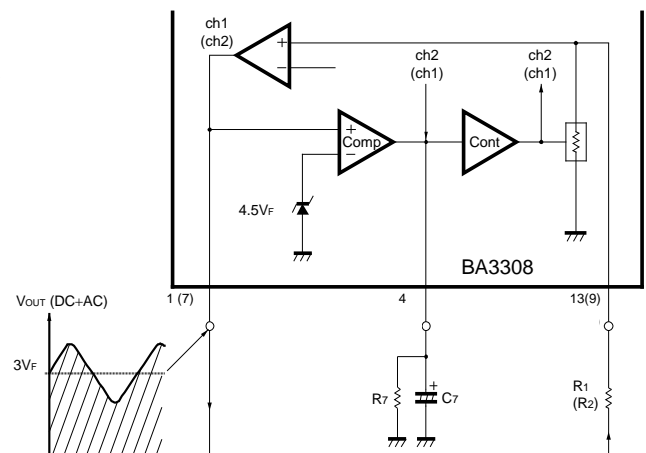


Fig.15

## 2. On playback

Since amplifier ch1 and ch2 are used as a NAB equalizer amplifier at playback, a time constant circuit is established in the NF section (1-11pin, 7-10pin) to obtain NAB characteristics. The voltage gain at this time is determined by the following formula:

$$G_v = |R_{11} + R_9 / (| + j\omega C_9 \cdot R_9) | / R_3$$

Obtain the necessary gain by regulating the (power-on pop noise prevention) NAB time constant circuit in the same way when regulating the gain at recording stage. The operating point of the output stage (1,7pin) is fixed at 3VF. Accordingly, even if VCC is raised to 5V or more, as in the VMAX-VCC characteristic (Fig.13), the maximum output voltage does not rise above 1.2V (Typ.). 4pin is grounded at playback since ALC is not needed. For better signal-to-noise ratio characteristics at playback, don't use R1 and R2, which are attached to the input pin (13pin, 9pin).

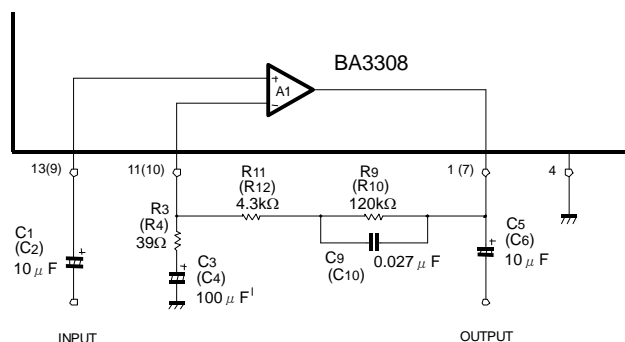


Fig.16

# ●Measurement circuit

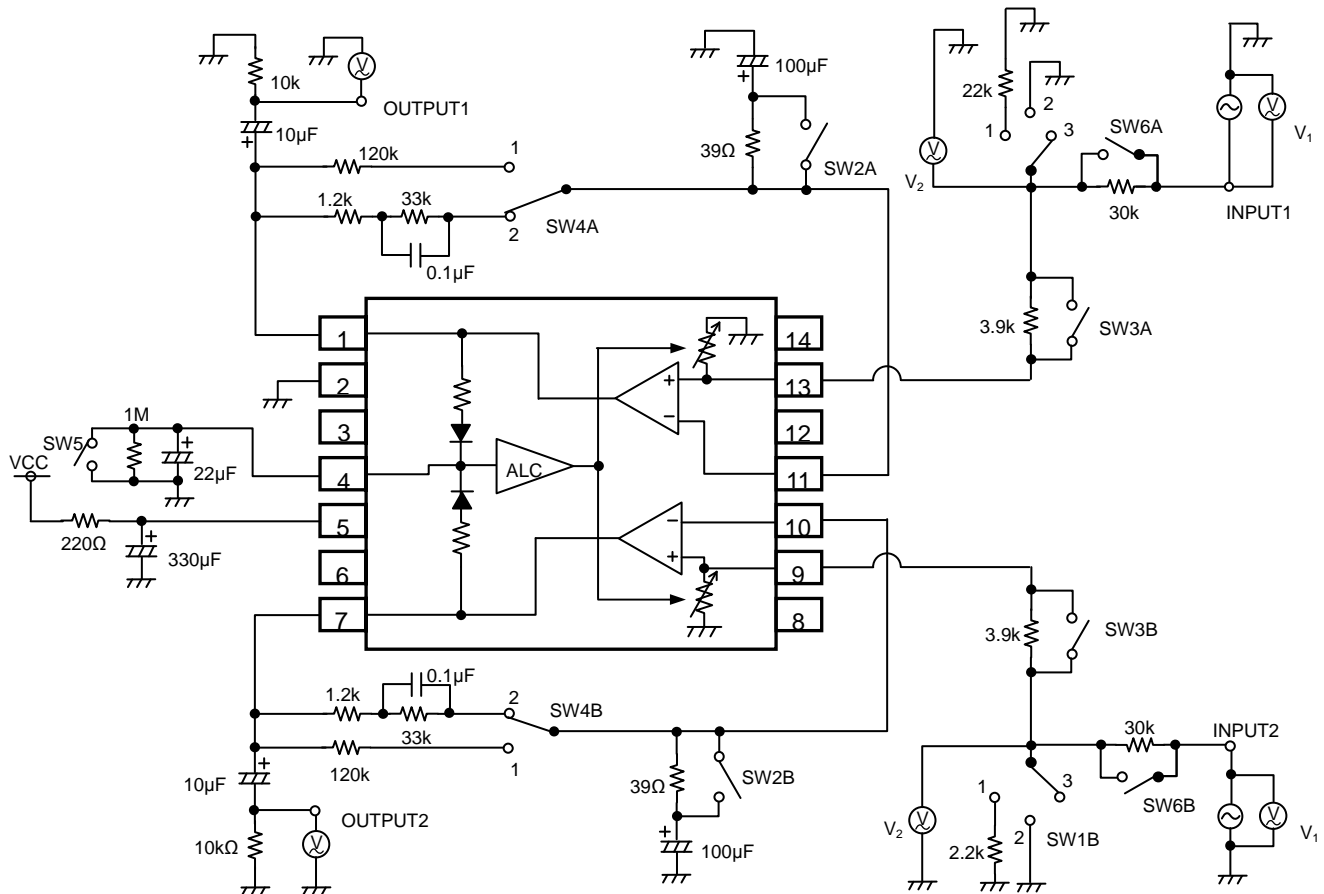


Fig.17

# ●Application circuit

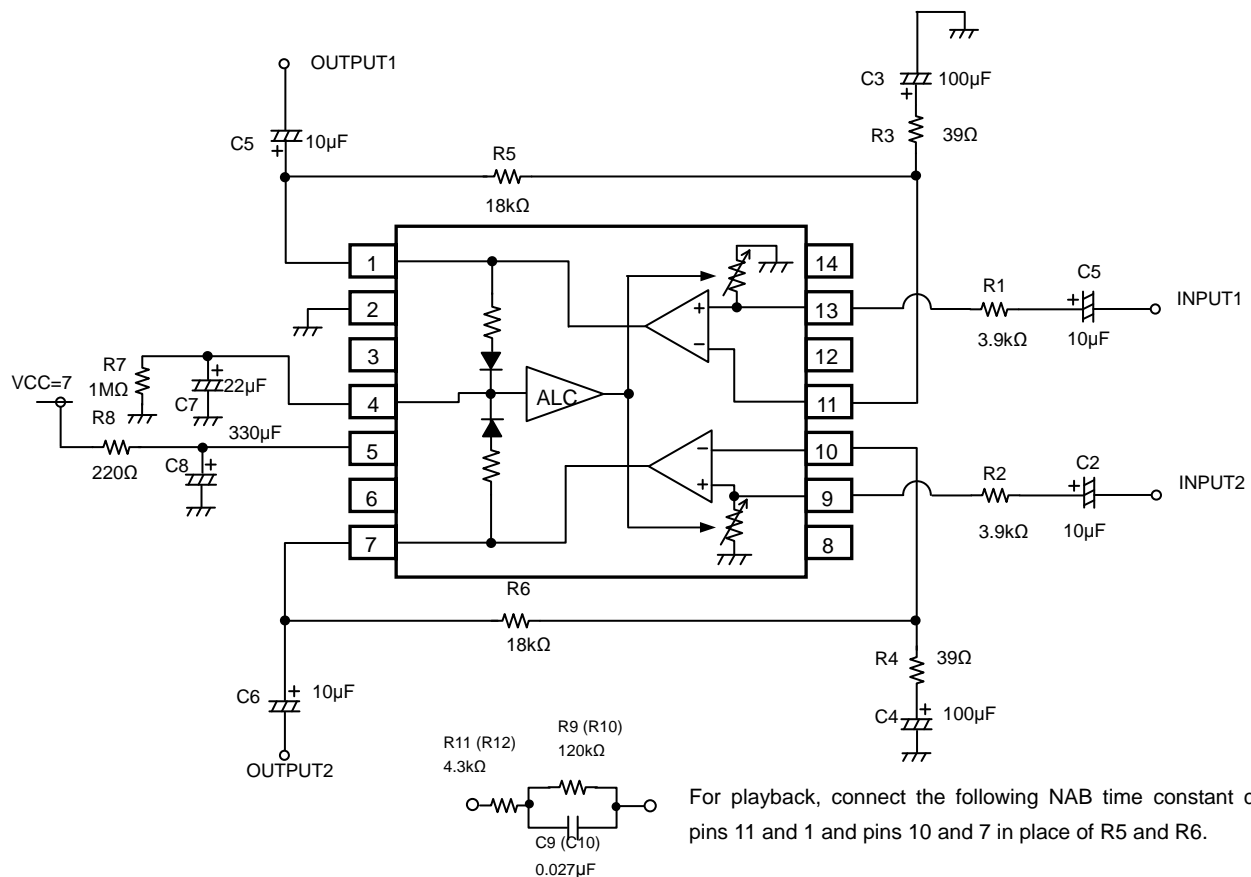


Fig.18

## ●Notes for use

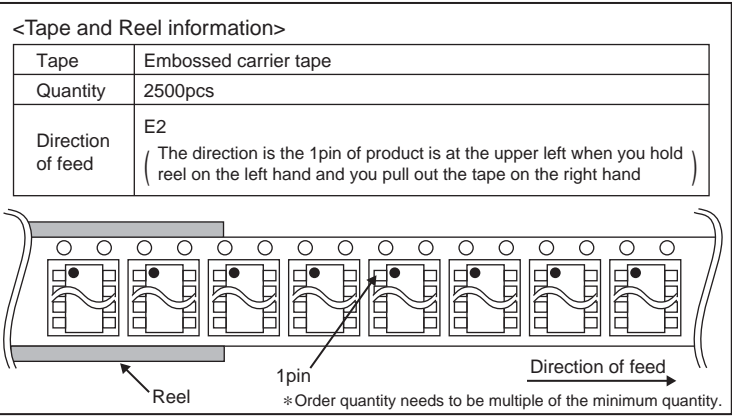
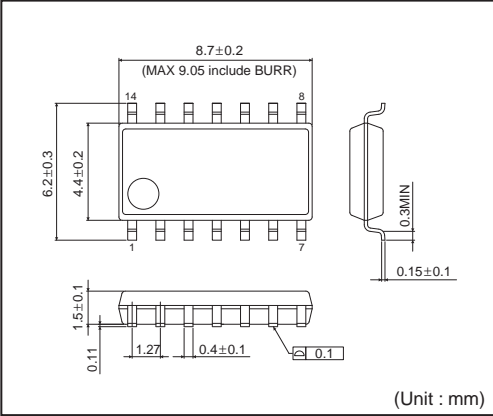
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- 6) Short circuit between terminals and erroneous mounting  
Pay attention to the assembly direction of the ICs. Wrong mounting direction or shorts between terminals, GND, or other components on the circuits, can damage the IC.
- 7) Operation in strong magnetic fields  
Using the ICs in a strong electromagnetic field can cause operation malfunction.
- 8) The BA3308F/FV has an on-chip power supply mute circuit that checks for pop noise at power-on. This prevents the occurrence of pop noise by timing the charge times of the direct current cut capacitors C3 and C4 of 10pin and 11pin, and of capacitor C8 for the ripple filter of 5pin.  
Accordingly, to obtain an adequate effect, it is recommended that the constants of the application circuit be used in C3, C4, R3, R4, C8, and R8.



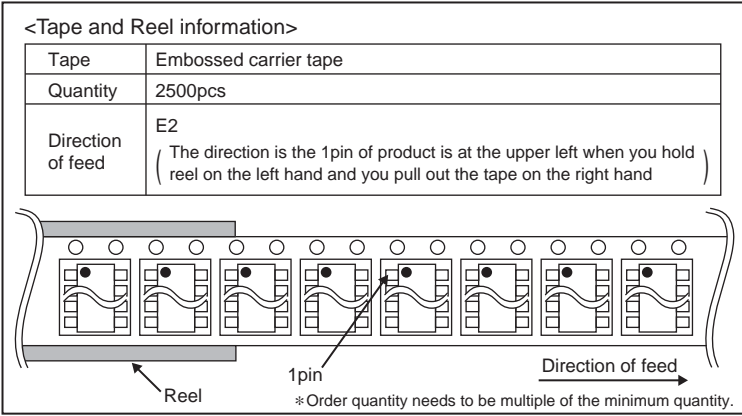
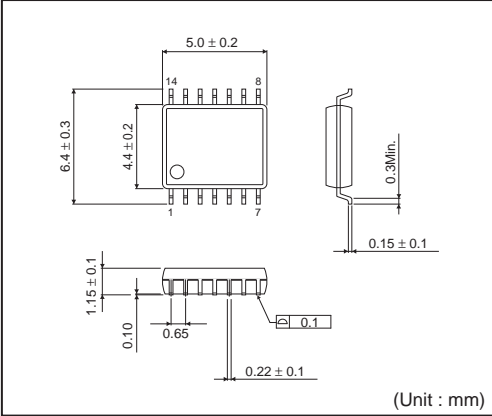
●Ordering part number

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B	A																			
3	3	0	8																	
F																				
E	2																			
Part No.		Part No.				Package		Packaging and forming specification												
						F: SOP14		E2: Embossed tape and reel												
						FV: SSOP-B14														

SOP14



SSOP-B14



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- In principle, the reflow soldering method must be used; if flow soldering method is preferred, please consult with the ROHM representative in advance.

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